

L Number	Hits	Search Text	DB	Time stamp
1	2917002	photoresist or photosensitive or resin or polymer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/09 12:45
2	166244	(photoresist or photosensitive or resin or polymer) with (cu ni sn au ag cr pd copper nickel tin gold silver chromium palladium)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/09 12:46
3	62993	(photoresist or photosensitive or resin or polymer) near3 (cu ni sn au ag cr pd copper nickel tin gold silver chromium palladium)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/09 12:47
4	4539	((photoresist or photosensitive or resin or polymer) near3 (cu ni sn au ag cr pd copper nickel tin gold silver chromium palladium)) with (etch\$4 pattern\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/09 12:47
5	1276	((((photoresist or photosensitive or resin or polymer) near3 (cu ni sn au ag cr pd copper nickel tin gold silver chromium palladium)) with (etch\$4 pattern\$4)) same (plating or plated or electroplat\$4)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/09 12:48
6	5	(((((photoresist or photosensitive or resin or polymer) near3 (cu ni sn au ag cr pd copper nickel tin gold silver chromium palladium)) with (etch\$4 pattern\$4)) same (plating or plated or electroplat\$4)) same adsorb\$4	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/09/09 12:48